HDJD-S822-QR999 RGB Color Sensor

Data Sheet



Description

HDJD-S822-QR999 is a high performance, small in size, cost effective light to voltage converting sensor. The sensor combines a photodiode array and three transimpedance amplifiers in a single monolithic CMOS IC solution. With a Red (R), Green (G) and Blue (B) color filters coated over the photodiode array, the sensor converts RGB light to analog voltage outputs, denoted by VROUT, VGOUT and VBOUT, respectively. The sensor is packaged in a 5x5x0.75 [mm] surface mount QFN-16 package.

Applications

- Ideal choice of for open loop and closed loop color identification
- Potential applications are such as general color detection, industrial process, environmental lighting, cabin lighting, decorative lighting and etc.

Features

- Convert light to R,G,B voltage output
- Monolithic CMOS IC solution comprises of an array of photodiode coated with R,G, B color filter and integrated with trans-impedance amplifier
- Independent gain selection options for each R,G,B channel
- Uniform photodiode array design to minimize the effect of contamination and optical aperture misalignment
- Robust package and small in size (5x 5x 0.75 mm)

Package Dimensions



Note: Dimensions are in millimeters (mm)

Part Numbering Systems



Pin Out for HDJD-S822-QR999

| Pin | Pin Name | Normal Operation |
|--------|-------------------|--|
| Pin 1 | VDD5 | 5 V DC Supply |
| Pin 2 | GND | Ground |
| Pin 3 | GSGRN0 | Gain Selection Green bit 0 |
| Pin 4 | VDD3 | 3.3V DC output test pin. To be connected to a decoupling capacitor of 100nF to ground is recommended |
| Pin 5 | TEST_EN | Tie to VDD3 via a 10k Ω pull up resistor |
| Pin 6 | GSRED1 | Gain Selection Red bit 1 |
| Pin 7 | NC | No connection |
| Pin 8 | GSGRN1 | Gain Selection Green bit 1 |
| Pin 9 | VR _{OUT} | Analog output voltage for RED |
| Pin 10 | VG _{OUT} | Analog output voltage for GREEN |
| Pin 11 | GSBLUE0 | Gain Selection Blue bit 0 |
| Pin 12 | VB _{OUT} | Analog output voltage for BLUE |
| Pin 13 | GSBLUE1 | Gain Selection Blue bit 1 |
| Pin 14 | NC | No connection |
| Pin 15 | NC | No connection |
| Pin 16 | GSREDO | Gain Selection Red bit 0 |

Theory of Operation

The integral R,G,B color filters on the photodiode array detect the R,G,B components of the light falling on the sensor. The photodiode convert the R,G,B light components into photocurrents. The integrated transimpedence amplifiers for R,G,B components then converts the photocurrent to analog voltage outputs. The voltage output of each R,G,B channel increases linearly with increasing light intensity.



Sensor IC Block Diagram

Absolute Maximum Ratings [1,2]

| Parameter | Symbol | Min | Мах | Unit | Notes |
|-----------------------------|------------------|-----|-----|------|----------------------------|
| Supply Voltage | V _{DD5} | 4.5 | 5.5 | ۷ | |
| Storage Temperature | Ts | -20 | 85 | °C | |
| Operating Temperature | T _A | -20 | 85 | °C | |
| Human Body Model ESD Rating | ESD HBM | | 2 | kV | Reference to JESD22-A114-B |

Note:

1. Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. Unless otherwise specified, voltages are referenced to ground.

Recommended Operating Conditions

| Parameter | Symbol. | Min | Тур | Max | Units | Note |
|-----------------------|-----------------|-----|-----|-----|-------|--|
| Operating Temperature | T _A | 0 | 25 | 70 | °C | |
| Supply Voltage | V _{DD} | | 5.0 | | V | A decoupling capacitor of 100nF between VDD and ground is recommended. |

Operating Conditions and Electrical Requirements

| Parameter | Symbol | Conditions | Min | Тур | Мах | Unit |
|------------------------------|--------------------|--|-----|------|-----|------------|
| Dark voltage | VD | Ee = 0 | | | 15 | mV |
| Maximum output voltage swing | V _{O MAX} | | | 3 | | V |
| Supply current | I _{DD} | Ee = 0 | | 3 | | mA |
| Parameter | Symbol | Remark | Min | Тур | Max | Unit |
| Irradiance Responsivity | Re | GS:00 $\lambda_P =$ 460 nm ^[1] (Blue Channel) | | 1.54 | | V/(mW/cm2) |
| | | GS:00 $\lambda_P = 542 \text{ nm}^{[2]}$ (Green Channel) | | 2.05 | | |
| | | GS:00 $\lambda_P = 645$ nm ^[3] (Red Channel) | | 2.73 | | |
| Irradiance Responsivity | Re | GS:11 λ_P = 460 nm ^[1] (Blue Channel) | | 0.77 | | V/(mW/cm2) |
| | | GS:11 λ_P = 542 nm ^[2] (Green Channel) | | 1.03 | | |
| | | GS:11 λ_P = 645 nm ^[3] (Red Channel) | | 1.37 | | |
| Irradiance Responsivity | Re | GS:01 λ_P = 460 nm ^[1] (Blue Channel) | | 0.39 | | V/(mW/cm2) |
| | | GS:01 λ_P = 542 nm ^[2] (Green Channel) | | 0.51 | | |
| | | $GS:01 \lambda_P = 645 \text{ nm} [3]$ (Red Channel) | | 0.68 | | |
| Irradiance Responsivity | Re | GS:10 λ_P = 460 nm ^[1] (Blue Channel) | | 0.21 | | V/(mW/cm2) |
| | | GS:10 $\lambda_P = 542$ nm ^[2] (Green Channel) | | 0.27 | | |
| | | GS:10 λ_P = 645 nm ^[3] (Red Channel) | | 0.36 | | |

Electrical Characteristics at V_{DD} = 5V, T_A = 25°C, RL = 68k Ω

| Parameter | Symbol | Remark | Min | Тур | Max | Unit |
|--|--------|---|--------|-------|-----|--------|
| Saturation Irradiance ^[4] | | GS:00 $\lambda_P =$ 460 nm ^[1] (Blue Channel) | | 1.95 | | mW/cm2 |
| | | GS:00 $\lambda_P = 542 \text{ nm}^{[2]}$ (Green Channel) | | 1.46 | | |
| | | GS:00 $\lambda_P = 645$ nm ^[3] (Red Channel) | | 1.10 | | |
| Saturation Irradiance ^[4] | | GS:11 λ_P = 460 nm ^[1] (Blue Channel) | | 3.90 | | mW/cm2 |
| | | GS:11 λ_P = 542 nm ^[2] (Green Channel) | | 2.93 | | |
| | | GS:11 λ_P = 645 nm ^[3] (Red Channel) | | 2.20 | | |
| Saturation Irradiance [4] GS:01 λ _P = 460 nm [1] 7.79 (Blue Channel) 7.79 | | | mW/cm2 | | | |
| | | GS:01 λ_P = 542 nm ^[2] (Green Channel) | | 5.85 | | |
| | | GS:01 $\lambda_P = 645$ nm ^[3] (Red Channel) | | 4.40 | | |
| Saturation Irradiance ^[4] | | GS:10 λ_P = 460 nm ^[1] (Blue Channel) | | 14.61 | | mW/cm2 |
| | | GS:10 λ_P = 542 nm ^[2] (Green Channel) | | 10.98 | | |
| | | GS:10 λ_P = 645 nm ^[3] (Red Channel) | | 8.24 | | |
| Output Rise Time | tr | GS:10 to GS11 Test Condition: Refer to note ^[5] | | 15 | | μs |
| | | GS:00 Test Condition: Refer to note ^[5] | | 110 | | |
| Output Fall Time | tf | GS:10 to GS11 Test Condition: Refer to note ^[5] | | 15 | | μs |
| | | GS:00 Test Condition: Refer to note ^[5] | | 120 | | |

Notes:

- 1. Test condition: using blue diffuse light of peak wavelength (λ_P) 460nm and spectral half width ($\Delta\lambda \lambda_2$) 20nm as light source.
- 2. Test condition: using green diffuse light of peak wavelength (λ_P) 542nm and spectral half width ($\Delta\lambda V_2$) 35nm as light source.
- 3. Test condition: using red diffuse light of peak wavelength (λ_P) 645nm and spectral half width ($\Delta\lambda \lambda_2$) 20nm as light source.
- Saturation irradiance = (Max output voltage swing)/(Irradiance responsivity)
- 5. Test condition: The rise and fall time is measured with RC lowpass filter added to sensor output:

| Gain Selection Rext | Cext |
|----------------------|------|
| GS:01 to GS:11 3.6kΩ | 1nF |
| GS:00 36kΩ | 1nF |

Test Circuit



Remarks: For illustration purpose, only red channel is shown. The same circuit applies to green and blue channel.

Gain Selection Feedback Resistor Table

| GSRED1 | GSRED0 | GSGRN1 | GSGRNO | GSBLUE1 | GSBLUE0 | Feedback Resistor |
|--------|---------------|--------|--------|---------|----------------|-------------------|
| 0 | 0 | 0 | 0 | 0 | 0 | 3.00 MΩ |
| 0 | 1 | 0 | 1 | 0 | 1 | 0.75 ΜΩ |
| 1 | 0 | 1 | 0 | 1 | 0 | 0.40 ΜΩ |
| 1 | 1 | 1 | 1 | 1 | 1 | 1.50 ΜΩ |

Notes:

1. Gains selections, GS: Bit 1 Bit 0 are applicable for each Red, Green and blue Channel.

- 2. Gain selections for each channel can be selected independently of each other.
- 3. Feedback resistor value is proportional to responsivity. Refer to block diagram below.
- 4. 0 indicates that the pin is connected to ground. 1 indicates no connection.







Figure 1. Spectral Responsivity

Note:

Test condition is when Gain Selection Jumpers are set to

| GSBLUE1 = 0 | GSGRN1 = 0 | GSRED1 = 0 | |
|-------------|------------|------------|--|
| GSBLUE0 = 0 | GSGRN0 = 0 | GSRED0 = 0 | |

In which 0 = connect to Ground, 1 = no connection.

Refer to Gain Selection Feedback Resistor Table.











It is recommended that Henkel Pb- free solder paste LF310 be used for soldering HDJD-S822-QR999. Below is the recommended reflow profile.



Figure 6. Recommended Reflow Soldering Profile

Figure 2. Dark Voltage vs Operating Temperature



Figure 5. Voltage output of red channel vs irradiance ($\lambda p = 645$ nm)

16 Lead QFN Recommended PCB Land Pad Design

IPC-SM-782 is used as the standard for the PCB land pad design. Recommended PCB finishing is Gold.



16 Lead QFN Recommended Stencil Design

A stencil thickness of 2.18mm (6 mils) for this QFN package is recommended.



Recommendations for Handling and Storage of HDJD-S822-QR999

This product is qualified as Moisture Sensitive Level 4 per Jedec J-STD-020. Precautions when handling this moisture sensitive product is important to ensure the reliability of the product. Do refer to Avago Application Note AN5305 Handling Of Moisture Sensitive Surface Mount Devices for details.

A. Storage before use

- Unopened moisture barrier bag (MBB) can be stored at 30°C and 90%RH or less for maximum 1 year
- It is not recommended to open the MBB prior to assembly (e.g. for IQC)
- It should also be sealed with a moisture absorbent material (Silica Gel) and an indicator card (cobalt chloride) to indicate the moisture within the bag

B. Control after opening the MBB

- The humidity indicator card (HIC) shall be read immediately upon opening of MBB
- The components must be kept at <30°C/60%RH at all time and all high temperature related process including soldering, curing or rework need to be completed within 72hrs

C. Control for unfinished reel

- For any unused components, they need to be stored in sealed MBB with desiccant or desiccator at <5%RH
- D. Control of assembled boards
- If the PCB soldered with the components is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <5%RH to ensure no components have exceeded their floor life of 72hrs

E. Baking is required if:

- "10%" or "15%" HIC indicator turns pink
- The components are exposed to condition of >30°C/60%RH at any time.
- The components floor life exceeded 72hrs
- Recommended baking condition (in component form): 125°C for 24hrs



Package Tape & Reel Dimensions

NOTES:

1. A₀ AND B₀ MEASURED AT 0.3 mm ABOVE BASE OF POCKET.

2. 10 PITCHES CUMULA TIVE TOLERANCE IS ± 0.2 mm.

3. DIMENSIONS ARE IN MILLIMETERS (mm).



NOTES: 1. *MEASURED AT HUB AREA. 2. ALL FLANGE EDGES TO BE ROUNDED.

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